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## **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled** 

## HEAT-RESISTANT COMPOSITE DIAMOND SINTERED PRODUCT AND METHOD FOR PRODUCTION THEREOF

the specification	on of which is attached hereto un	nless the following is che	cked		
was filed of 2003 as PCT In	on 17. June. 2005 as United Stat International Application Number	es Application Number _ r <u>PCT/JP2003/014763</u> ar	and was filed on od was amended on 08. July.	19. November. 2004(if applicable).	
I hereby state claim(s), as an	that I have reviewed and underst nended by any amendment refer	and the contents of the atred above.	pove-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pate	entability as defined in Title?	37, Code of Federal	
for patent or in	foreign priority benefits under I aventor's certificate listed below ificate having a filing date befor	and have also identified	below any foreign applicatio	eign application(s) n for patent or	
				Priority Claimed	
(List prior foreign applications. See	2002-367354	Japan	10/Dagamban/2002		
note A)	(Number)	(Country)	18/December/2002 (Day/Month/Year Filed)	⊠ Yes ☐ No	
•	(Itamoci)	(Country)	(Day/Monul/ Fear Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				Yes No	
	(Number)	(Country)	(Day/Month/Year Filed)	<del></del>	
(See note B)	See attached list for additional	prior foreign applications	3		
insofar as the s in the manner j information wh	the benefit under Title 35, Unite ubject matter of each of the claim provided by the first paragraph which is material to patentability a ecame available between the filibilication.	ms of this application is n of Title 35, United States s defined in Title 37, Cod	ot disclosed in the prior Uni Code, § 112, I acknowledge le of Federal Regulations	ted States application the duty to disclose	
			Stati	18	
(List prior U.S.					
Applications)	(4 1) (7 1 1 2 2 2		Patented Pend	ing Abandoned	
	(Application Serial No.)	(Filing Date)			
	(Application Serial No.)	(Filing Date)	Patented Pend	ing	
	(Application Serial No.)	(Filing Date)			
Patented Pending Aba					
	(Application Serial No.)	(Filing Date)	ratented Pend	mg [ ] Abandoned	
	(pp. canon borial 110.)	(I ming Date)		•	
			Patented Pend	ng Abandanad	
	(Ameliantian Carial Na.)	(Elling Data)		ng [1] Availdoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

## **Customer Number: 38834**

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Full name of sole or first inventor (given name, family name)		Minoru AKAISHI		
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		nventor (given name, family name)	Keigo KAWAMURA		
	Inventor's signature	Keigo Kanamural	Date 2/ December / 2005		
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	Post Office Address	10-26, Nishikicho, Furano-shi, Hokkaido 076-0028 Japan			
			<del></del>		
		entor (given name, family name)			
	Inventor's signature		Date		
	Residence		Citizenship		
	Post Office Address				

## **NOTES**

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.